

STTH200R04TV

Ultrafast recovery diode

Main product characteristics

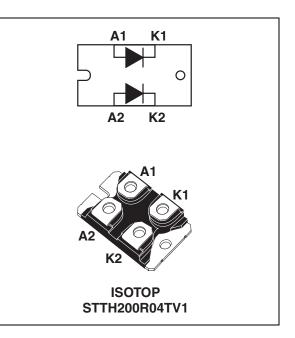
I _{F(AV)}	2 x 100 A
V _{RRM}	400 V
Тj	150° C
V _{F (typ)}	0.87 V
t _{rr (typ)}	40 ns

Features and benefits

- Ultrafast
- Very low switching losses
- High frequency and high pulsed current operation
- Low leakage current
- Insulated package:
 - ISOTOP
 Electrical insulation = 2500 V_{RMS}
 Capacitance = 45 pF

Description

The STTH200R04TV series uses ST's new 400 V planar Pt doping technology. The STTH200R04 is specially suited for switching mode base drive and transistor circuits, such as welding equipment.



Order codes

Part Number	Marking
STTH200R04TV1	STTH200R04TV1

1 Characteristics

Table 1	Absolute retings (limiting values per diade at 25° C upless athemysics specified)
Table 1.	Absolute ratings (limiting values per diode at 25° C, unless otherwise specified)

Symbol	Parameter				Unit
V _{RRM}	Repetitive peak reverse voltage			400	V
V _{RSM}	Non repetitive peak reverse voltage			400	V
I _{F(RMS)}	RMS forward current Per diode			150	А
		Per diode	$T_c = 80^\circ C$	100	А
^I F(AV)	Average forward current, $\delta = 0.5$	Per package	$T_c = 65^\circ C$	200	А
I _{FRM}	Repetitive peak forward current	t _p = 5 μs, F = 1 kHz square		2000	А
I _{FSM}	Surge non repetitive forward current t _p = 10 ms Sinusoidal			1000	А
T _{stg}	Storage temperature range			-65 to + 150	°C
Тj	Maximum operating junction temperature			150	°C

Table 2.Thermal parameters

Symbol	Parameter		Value	Unit
P	Junction to case	Per diode	0.50	
R _{th(j-c)}		Total	0.30	° C/W
R _{th(c)}	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \times R_{th(j-c)} \text{ (per diode)} + P_{(diode2)} \times R_{th(c)}$

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _B ⁽¹⁾	Povorco lookago ourront	T _j = 25° C	V - V			80	
'R` ′	IR ⁽¹⁾ Reverse leakage current	T _j = 125° C	V _R = V _{RRM}		80	800	μA
		T _j = 25° C				1.35	
V _F ⁽²⁾	V _F ⁽²⁾ Forward voltage drop	T _j = 100° C	I _F = 100 A		0.95	1.2	V
		T _j = 150° C]		0.87	1.1	

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2 \%$

2. Pulse test: t_p = 380 µs, δ < 2 %

To evaluate the conduction losses use the following equation: P = 0.8 x $I_{F(AV)}$ + 0.003 x ${I_{F}}^{2}{}_{(RMS)}$



Table 4.	Dynamic characteristics
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Symbol	Parameter	Test conditions	Min.	Тур	Max.	Unit
		$\label{eq:IF} \begin{array}{l} I_F = 1 \ A, \ dI_F/dt = \text{-50 } A/\mus, \\ V_R = 30 \ V, \ T_j = 25^\circ \ C \end{array}$			100	
t _{rr} Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s},$ $V_R = 30 \text{ V, } T_j = 25^\circ \text{ C}$		50	70	ns	
	$I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s},$ $V_R = 30 \text{ V, } T_j = 25^\circ \text{ C}$		40	55		
I _{RM}	Reverse recovery current	$ I_F = 100 \text{ A}, \text{ dI}_F/\text{dt} = -200 \text{ A}/\mu\text{s}, \\ V_R = 320 \text{ V}, \text{ T}_j = 125^\circ \text{ C} $		22	32	А
Q _{RR}	Reverse recovery charges	$I_F = 100 \text{ A}, \text{ dI}_F/\text{dt} = -200 \text{ A}/\mu\text{s},$ $V_R = 320 \text{ V}, \text{ T}_j = 125^{\circ} \text{ C}$		1500	2900	nC
S	Softness factor	$I_F = 100 \text{ A}, \text{ dI}_F/\text{dt} = -200 \text{ A}/\mu\text{s},$ $V_R = 320 \text{ V}, \text{ T}_j = 125^{\circ} \text{ C}$		0.4		
t _{fr}	Forward recovery time	$I_F = 100 \text{ A}$ $dI_F/dt = 100 \text{ A}/\mu \text{s}$ $V_{FR} = 1.5 \text{ x} V_{Fmax}$, $T_j = 25^{\circ} \text{ C}$		1000		ns
V _{FP}	Forward recovery voltage	I_{F} = 100 A, dI_{\text{F}}/dt = 100 A/µs, T_{j} = 25° C		3.5		V

Figure 1. Conduction losses versus average current

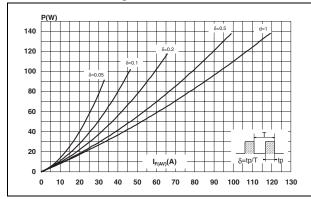
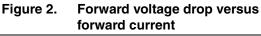


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

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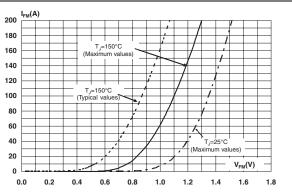
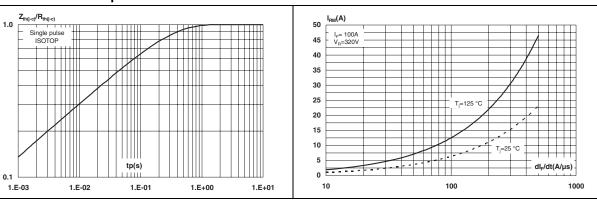


Figure 4. Peak reverse versus dl_/d

Peak reverse recovery current versus dl_F/dt (typical values)



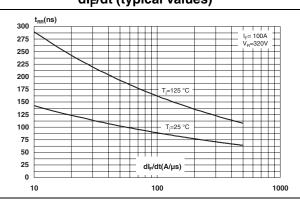
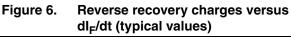


Figure 5. Reverse recovery time versus dl_F/dt (typical values)



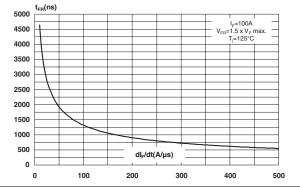


Figure 7. Relative variations of dynamic parameters versus junction temperature

Figure 8. Transient peak forward voltage versus dl_F/dt (typical values)

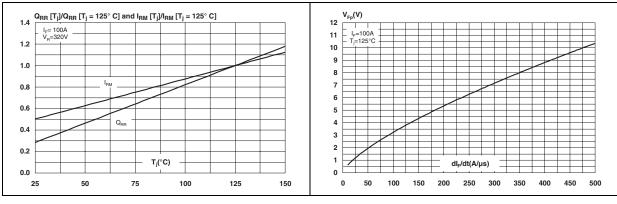
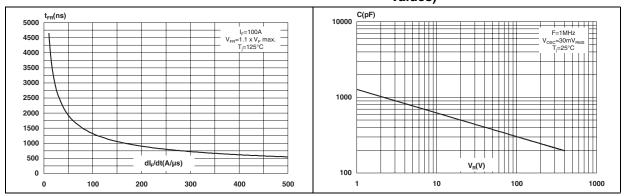


Figure 9. Forward recovery time versus dl_F/dt Figure 10. (typical values)

Junction capacitance versus reverse voltage applied (typical values)



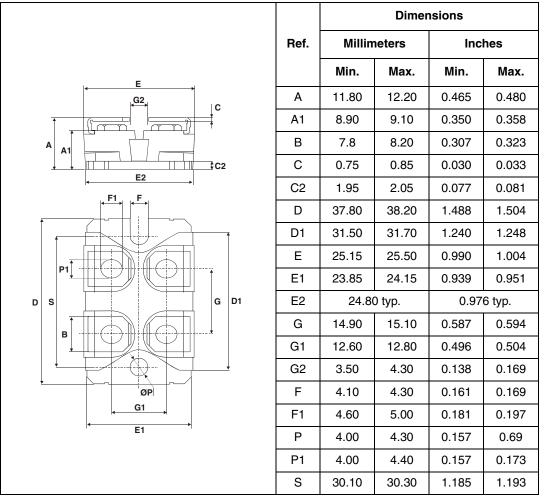


2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Table 5. ISOTOP dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH200R04TV1	STTH200R04TV1	ISOTOP	27 g	10	Tube

4 Revision history

Date	Revision	Description of Changes
31-Mar-2007	1	First issue



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